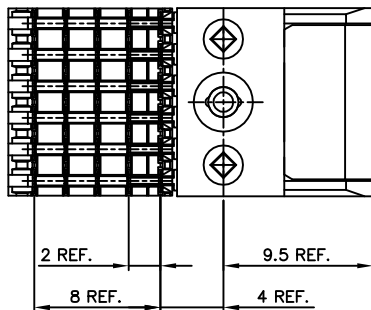
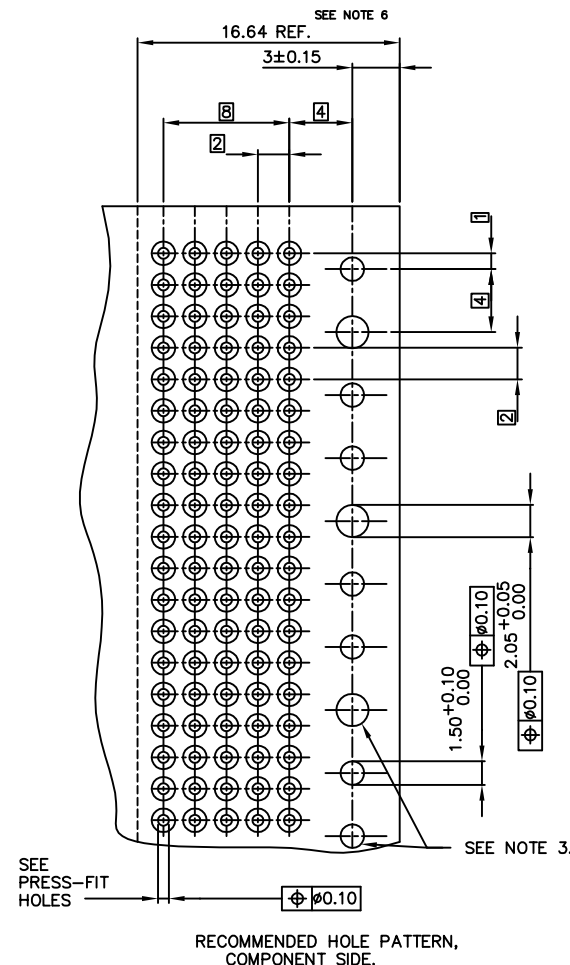
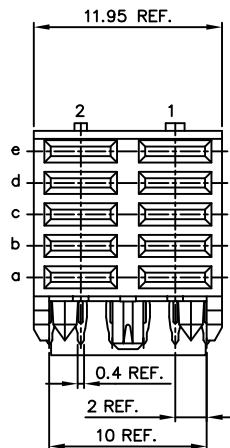
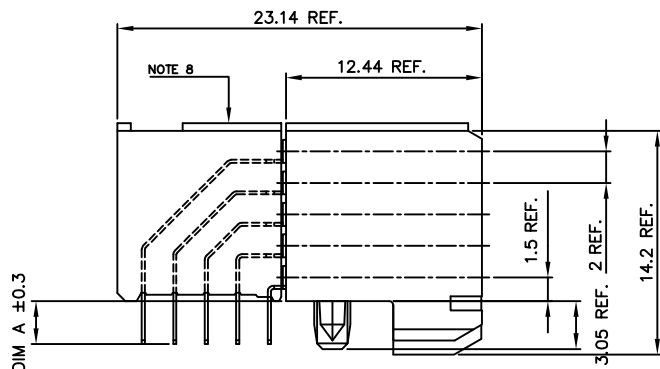




PC BOARD VERSIONS		
PRODUCT NR	PCB THICKNESS	DIM A
63791-X02	1.6	2.73
63791-X12	2.4 OR 3.2	3.53
63791-X02LF	1.6	2.73
63791-X12LF	2.4 OR 3.2	3.53

PRESS-FIT HOLES	
HOLE DIAMETER	
AFTER PLATING	0.65-0.80
DRILLED HOLE	0.81-0.86
COPPER PLATING	0.025 MIN.
SnPb PLATING	0.005-0.015



- NOTES:
- 1 BODY MAT'L: LIQUID CRYSTAL POLYMER 30% GLASS FLAME RETARDANT ACC. UL 94-V0
 - 2 TERMINAL MATERIAL: PHOSPHOR BRONZE.
 - 3 INDICATED HOLES ARE UNPLATED.
 - 4 PLATING OF COMPLIANT SECTIONS 0.5-1.5 μ m SnPb 85-97 OR 0.5-1.5 μ m PURE Sn FOR LF.
 - 5 PRODUCT MARKING: PART NUMBER & BATCH ID.
 - 6 SET BACK FOR PRESS BLOCK
 - 7 SEE TA-941 FOR -XY2/XY2LF APPLICATION TOOLING
 - 8 TOP SURFACE OF PRESS BLOCK MAY EXTEND UP TO 0.4MM HIGHER THAN HOUSING. THIS MAY AFFECT THE TAIL LENGTH BEFORE APPLICATION TO A BOARD.
 - 9 THIS PRODUCT WITH "LF" SUFFIX MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS -22-008.
 - 10 THE PRODUCT IS NOT INTENDED TO BE EXPOSED TO A MANUFACTURE AND SOLDER PROCESS.

PRODUCT NR	PLATING CONTACT AREA	UNDERPLATING
63791-1Y2/1Y2LF	0.8 μ m GOLD	1.3 μ m Ni min.
63791-2Y2/2Y2LF	2.0 μ m GOLD	1.3 μ m Ni min.
63791-3Y2/3Y2LF	1.3 μ m GOLD	1.3 μ m Ni min.
63791-9Y2/9Y2LF	0.8 μ m GXT	1.3 μ m Ni min.

mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY		FCI Electronics	
ltr	ecn no	dr	date	linear	.XX±.13	projection		www.fciconnect.com	
A	V11875	JWS	07/16/01		.XXX±.051			title	
B	DG05-0342	CLU	092005	angles	O' ±2'			5R RECEPTACLE POWER	
C	DG08-0171	Cenh	10/08/08	dr	J. SHAFFER 5/31/00	MM		RA PF THICKCARD 12MM ASS'Y	
				enrg	S. MINICH 5/31/00	scale		product family METRAL (tm)	
				chr	S. MINICH 5/31/00	1:1		size dwg no	
				appd	S. MINICH 5/31/00			A 63791	
sheet index	revision sheet	C	1					code 213	
								sheet 1 of 1	

cage code 22526